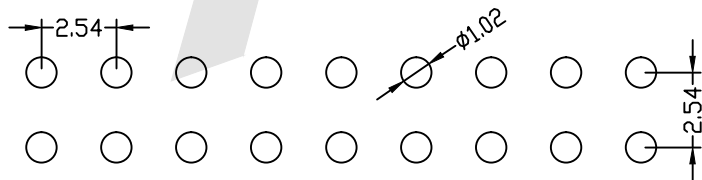
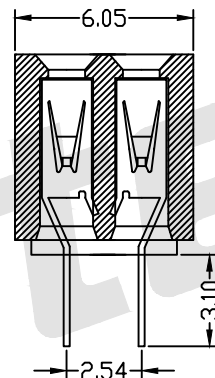
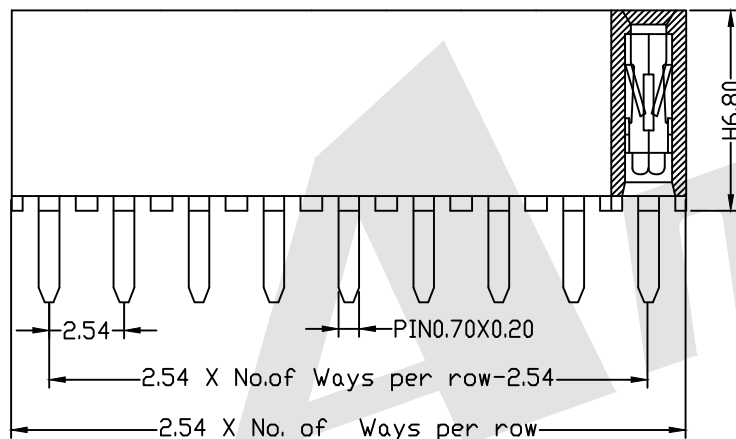
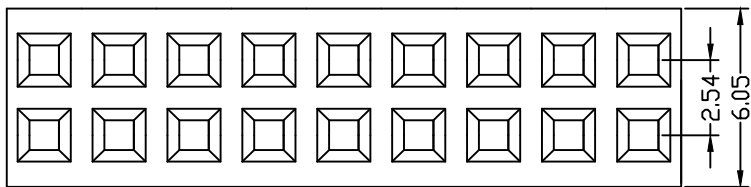


HSF



PCB LAYOUT

SPECIFICATION

Current Rating: 3.0 Amp
 Insulation Resistance: 1000M ohms min
 Contact Resistance: 20M ohms max
 Dielectric Withstanding: AC500V
 Operating Temperature: -65°C to +125°C
 Contact Material: Brass
 Insulator Material: PBT,UL 94V-0 Black

Ordering Code:

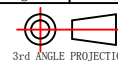
FHES16 - X - X - D - X - X - X
 ① ② ③ ④ ⑤ ⑥ ⑦

- ① Series No:
- ② No. of Contacts: 02 To 80
- ③ Contact Plating:
 - G0: Gold flash S0: Selective
 - G1: 3u" Gold S1: Selective 3u" ⑦
 - G2: 5u" Gold S2: Selective 5u"
 - G3: 10u" Gold S3: Selective 10u"
 - G4: 15u" Gold S4: Selective 15u"
 - G5: 30u" Gold S5: Selective 30u"
 - SN: Tin
- ④ Connector Type: D: Dual
- ⑤ Plastic High: H: 6.8
- ⑥ Insulator Material:
 - A: PBT
 - B: PA6T
 - C: LCP
 - D: PA46
 - E: PA9T
 - ⑦ Packing: A: Tray, B: Bag, T: Tube, U: Tube+CAP, R: Tape&Reel, W: Tape&Reel+CAP

Please mark the desired length in the H

Unless otherwise specified tolerance
 X. ±0.35 X.XX: ±0.20
 X.X: ±0.25 X.XXX: ±0.15

SCALE: As Shown UNIT: mm
 DRAW: YG ZHONG DATE: 01/05/2016
 CHECK: BobYang DATE: 01/05/2016



Antenk ANTENK ELECTRONICS CO., LTD
 Http://www.antenk.com
 E-mail: sales@antenk.com

TITLE:
 2.54mm Female Header Dual Row Straight Type

DRAWING NO: FHES16-XXDXXX

PRODUCT NO: FHES16-XXDXXX

REV	DESCRIPTION	DATE